野火_i.MX 6ULL核心板_原理图_V1.0

目录

Page 1	目录
Page 2	历史版本
Page 3	CPU电源
Page 4	CPU PERI x1
Page 5	CPU PERI x2
Page 6	DDR3L
Page 7	eMMC/NAND FLAH
Page 8	BOOT CFG
Page 9	引出IO
Page 10	FUSE MAP
Page 11	
Page 12	

东莞野火电子技术有限公司
https://fire-stm32.taobao.com

野火_i.MX 6ULL核心板_原理图

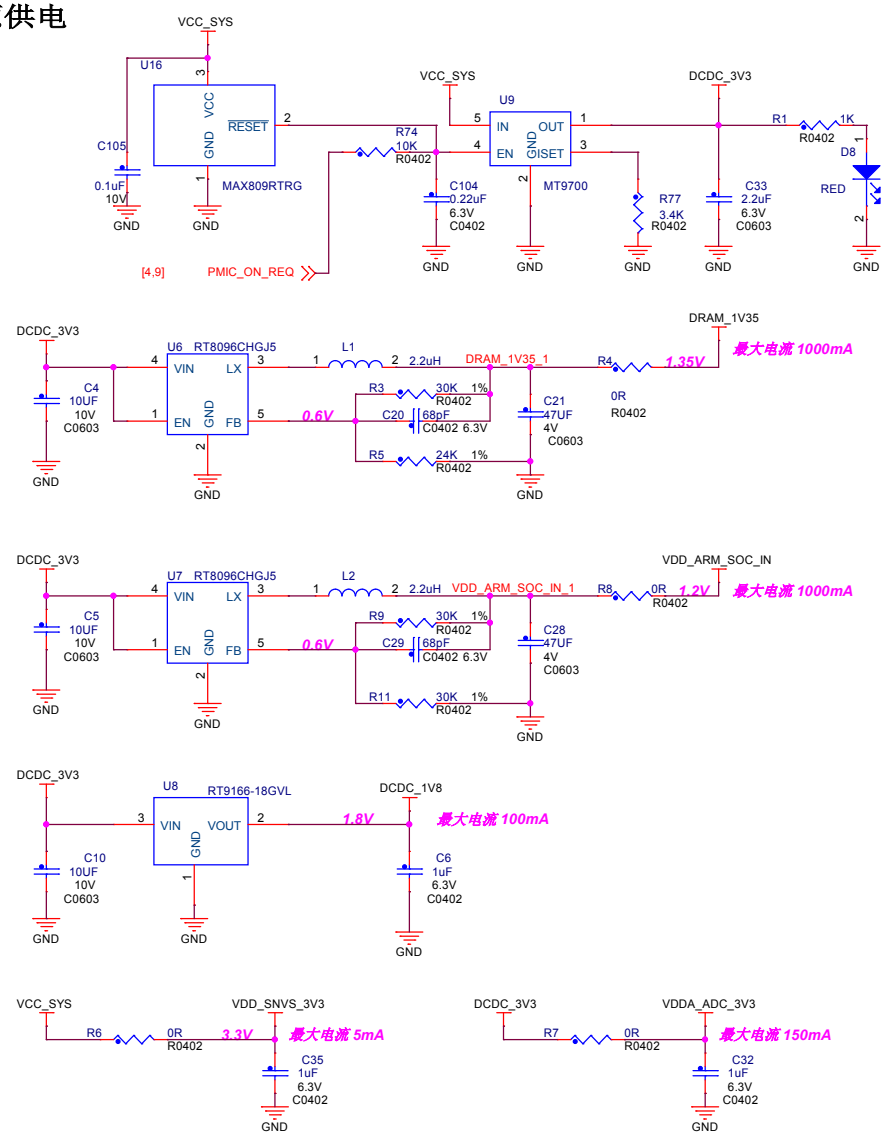
A3 | 目录 | V1.0

Monday, November 25, 2019 | 1 | 10

历史版本

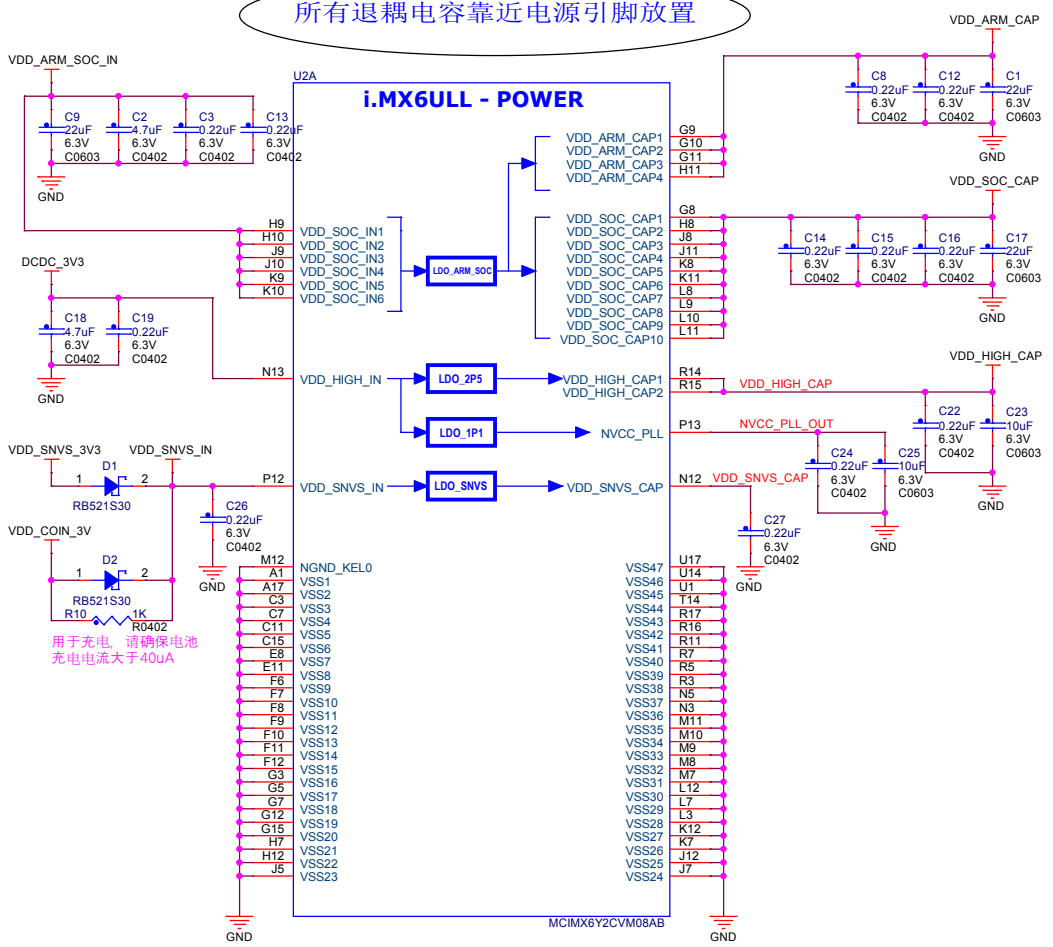
版本号	日期	设计	描述
V1.0	2019-05-30	cancore	初始版本
V1.0	2019-12-31	cancore	整理对外发布，稳定版

电源供电

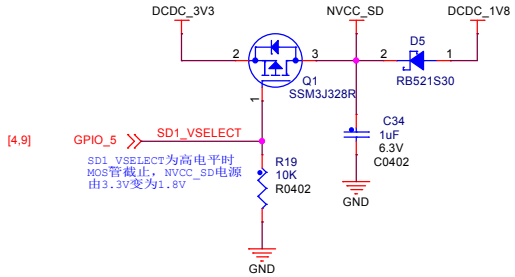


MPU电源

所有退耦电容靠近电源引脚放置



SD3.0供电切换电路

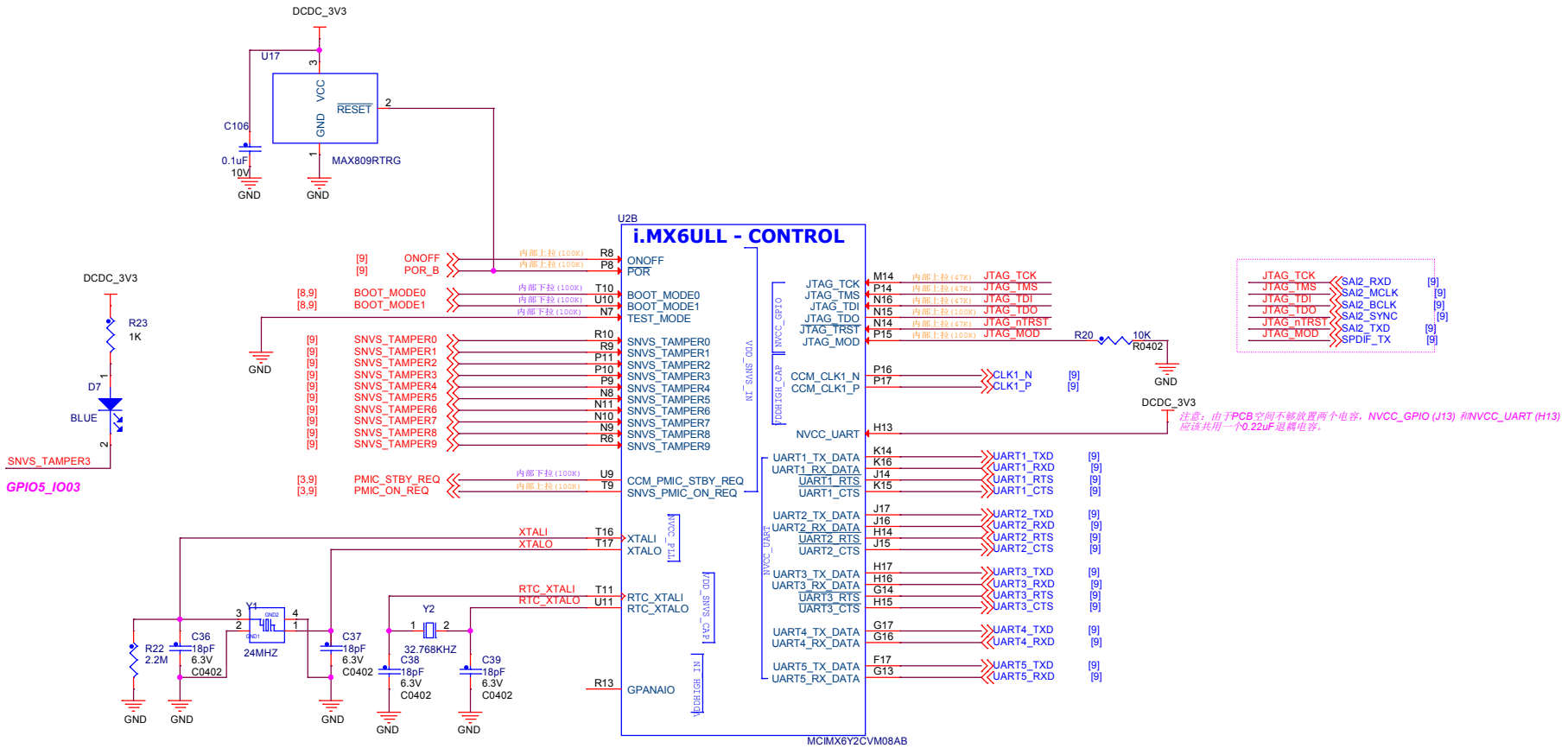


H1 2.0mm H2 2.0mm

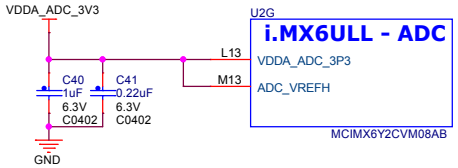
GND GND

东莞野火电子技术有限公司 https://fire-stm32.taobao.com		
野火_i.MX 6ULL核心板_原理图		
A3	CPU电源	V1.0
Monday, November 25, 2019	3	10

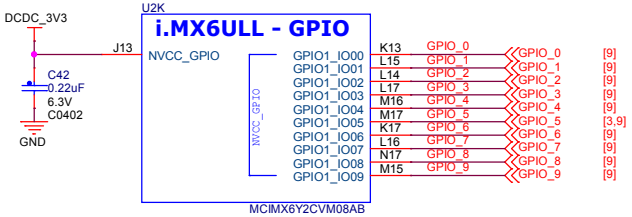
MX6ULL



ADC供电



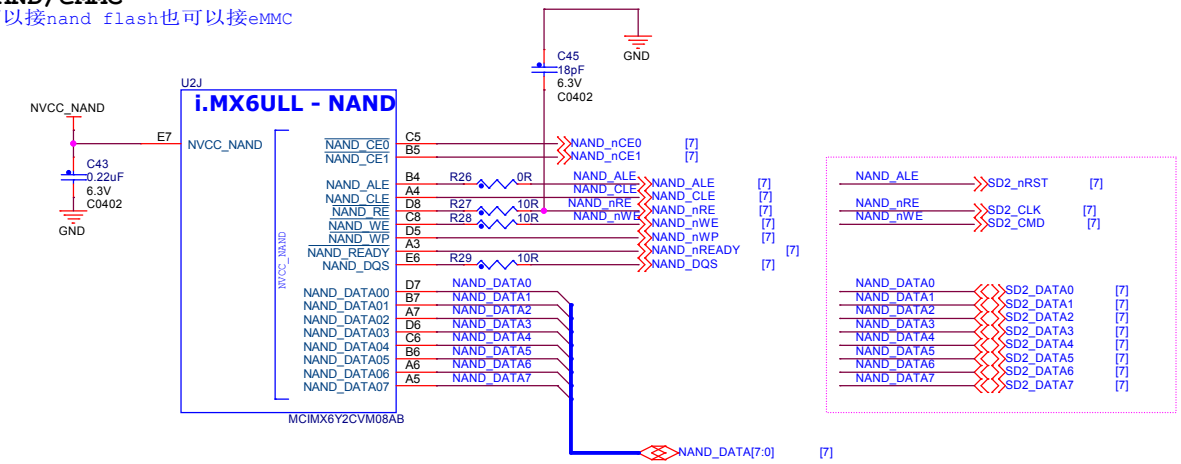
GPIO



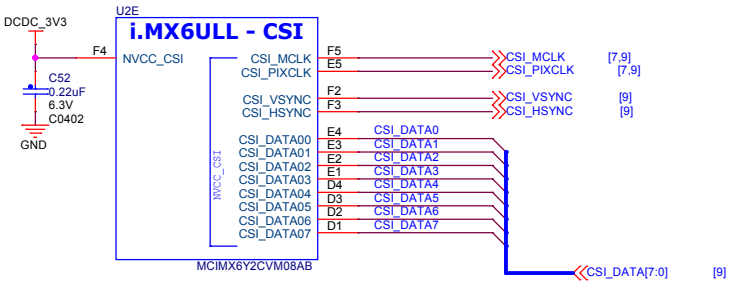
东莞野火电子技术有限公司 https://fire-stm32.taobao.com		
野火_i.MX 6ULL核心板_原理图		
A3	CPU PERI x1	V1.0
Monday, November 25, 2019	4	10

NAND/eMMC

可以接nand flash也可以接eMMC

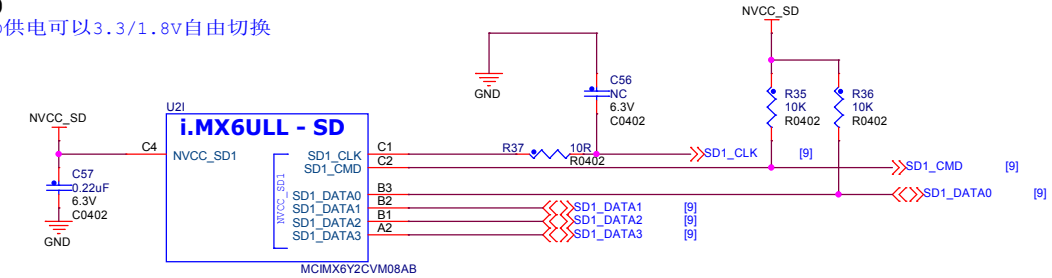


摄像头-8bit

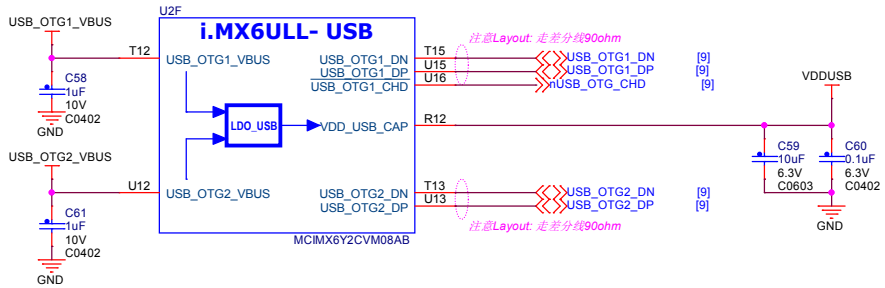


SD3.0

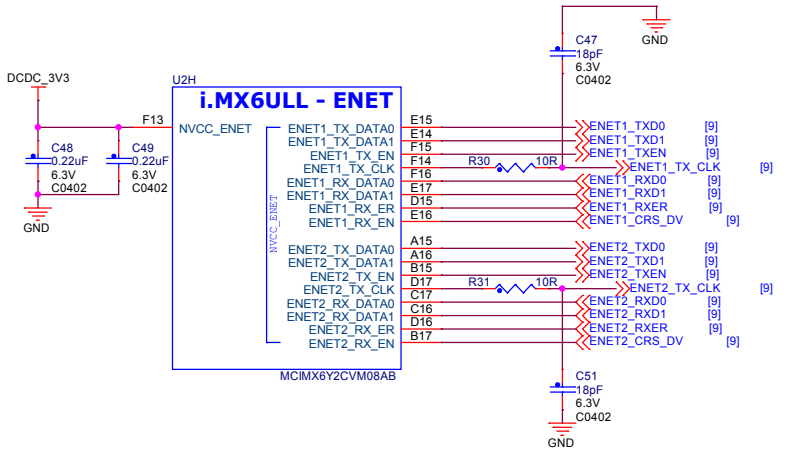
NVCC_SD供电可以3.3/1.8V自由切换



USB



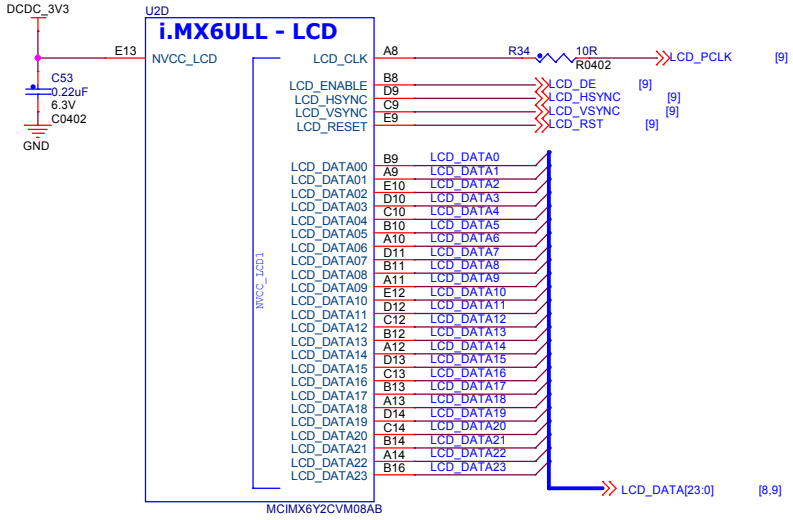
100M MII/RMII以太网



LCD888-24bit

最高支持分辨率为1366*768

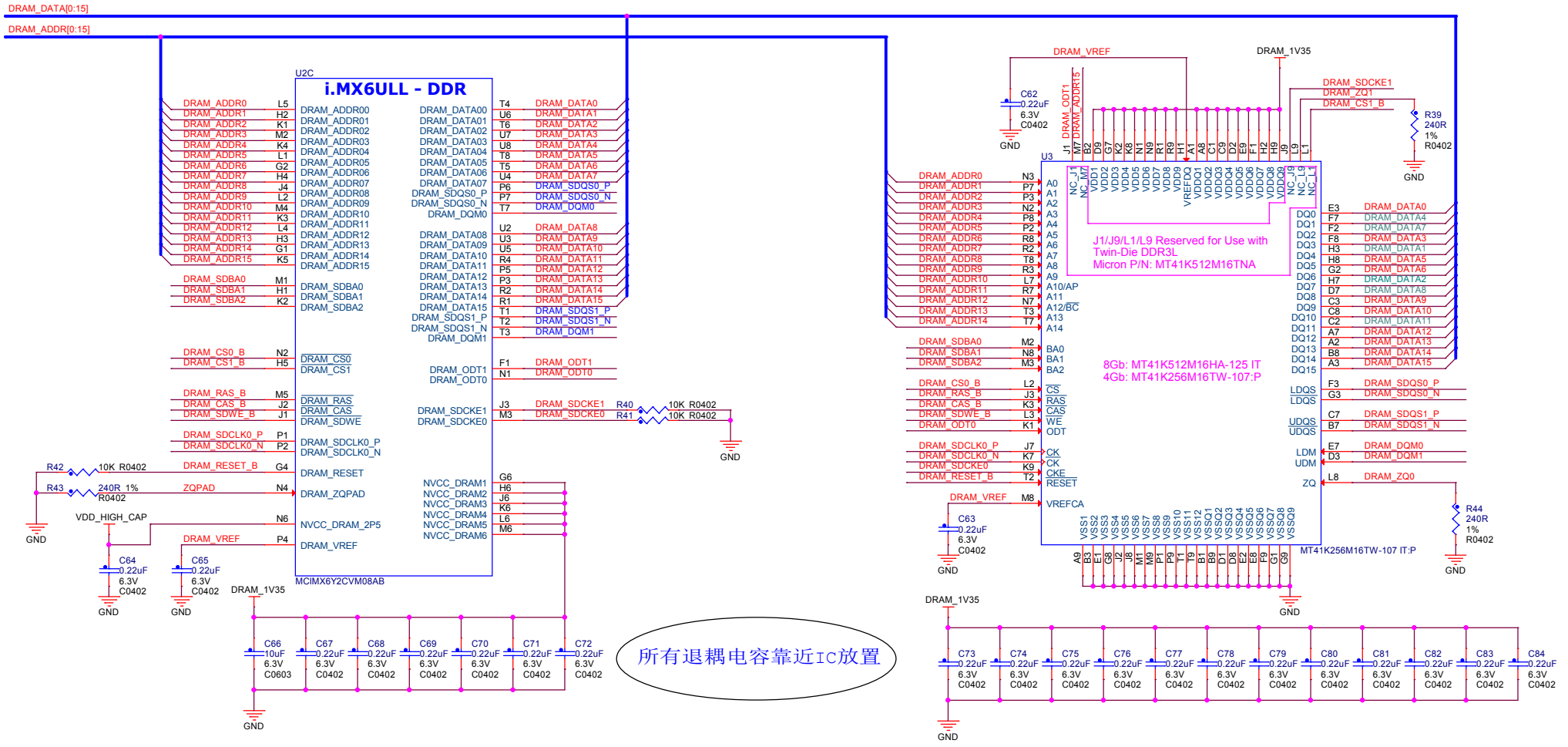
最高支持像素时钟为85MHz

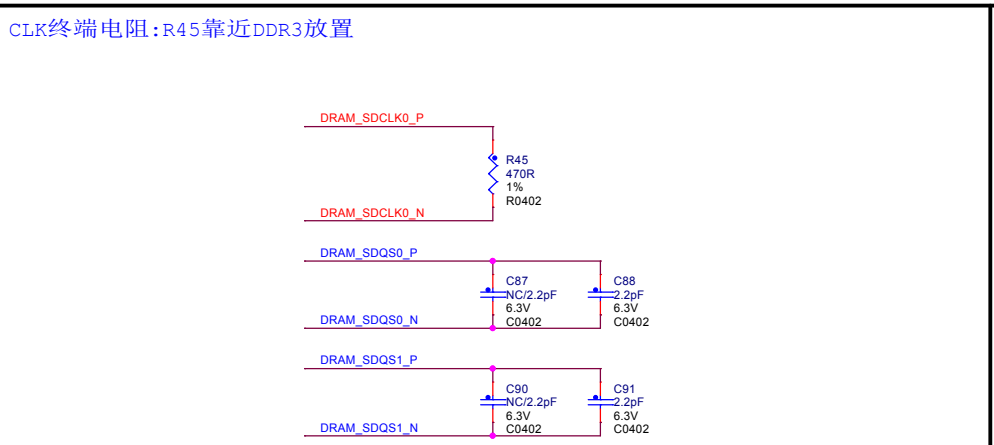


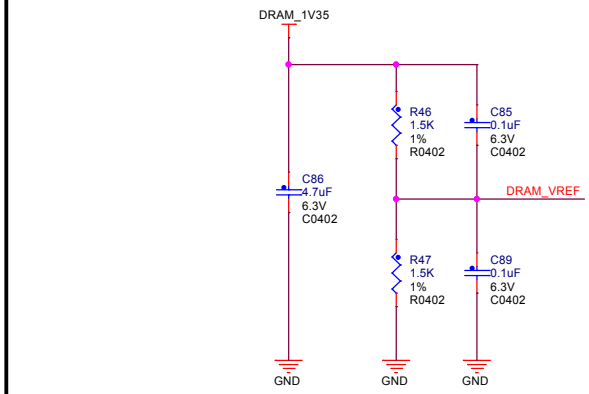
东莞野火电子技术有限公司 https://fire-stm32.taobao.com		
野火_i.MX 6ULL核心板_原理图		
A3	CPU PERI x2	V1.0
Monday, November 25, 2019	5	10

DDR3L

默认容量为512M字节，16位宽，低电压1.35V



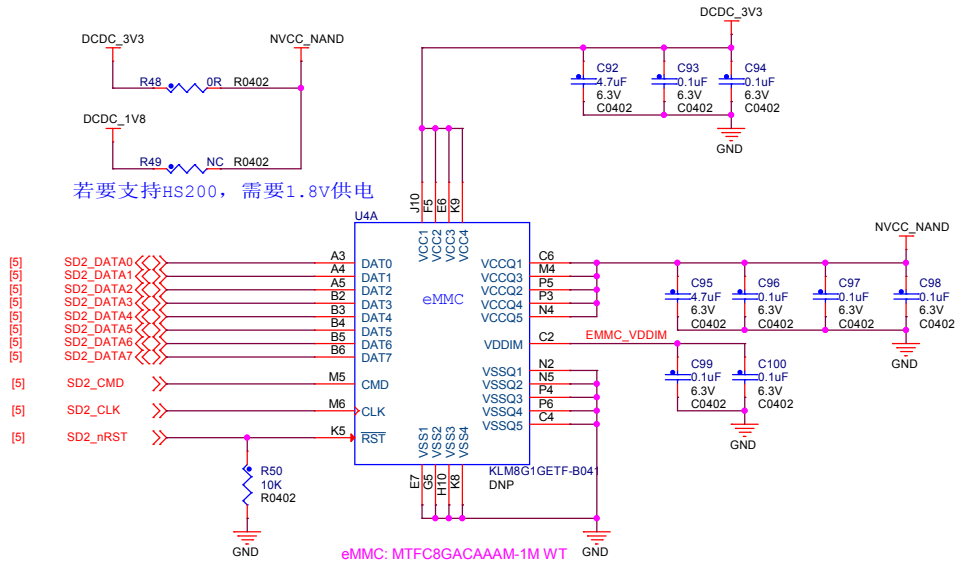


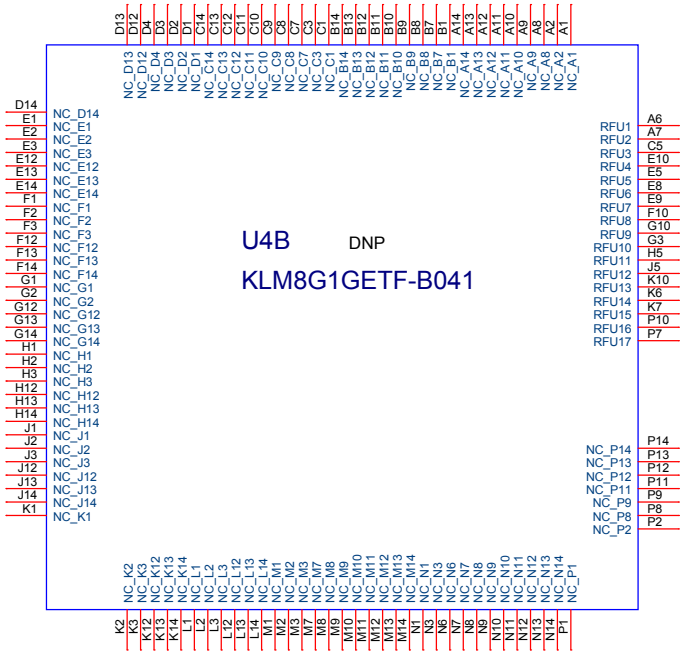


东莞野火电子技术有限公司 https://fire-stm32.taobao.com		
野火_i.MX 6ULL核心板_原理图		
A3	DDR3L	V1.0
Monday, November 25, 2019	6	10

eMMC

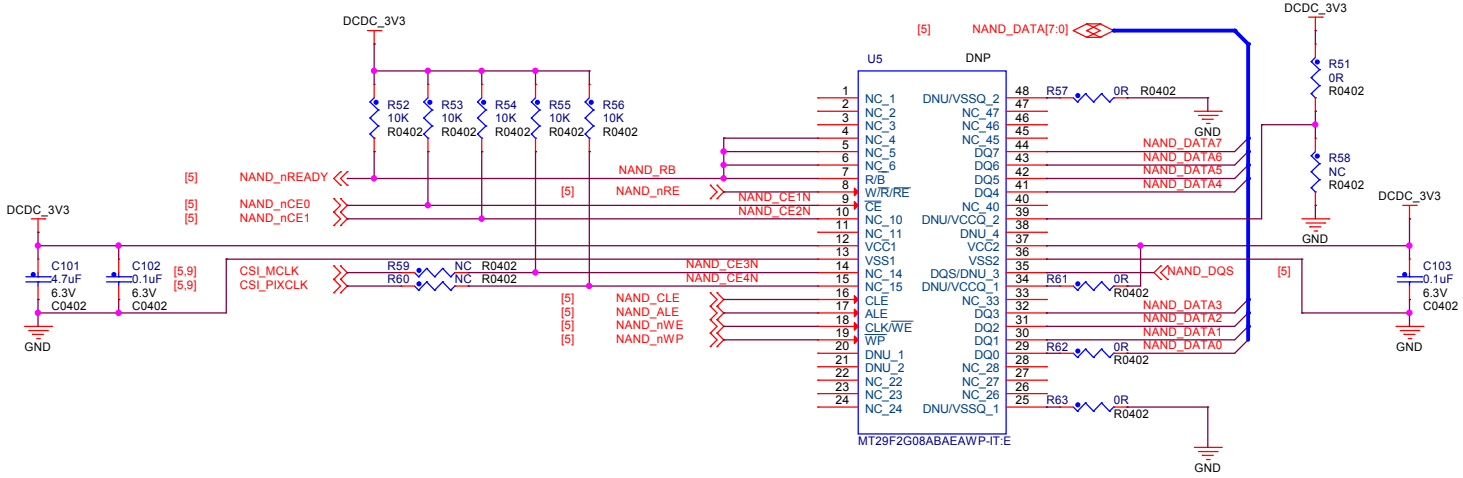
默认容量为8G字节





NAND FLASH

默认容量为256M字节，8bit



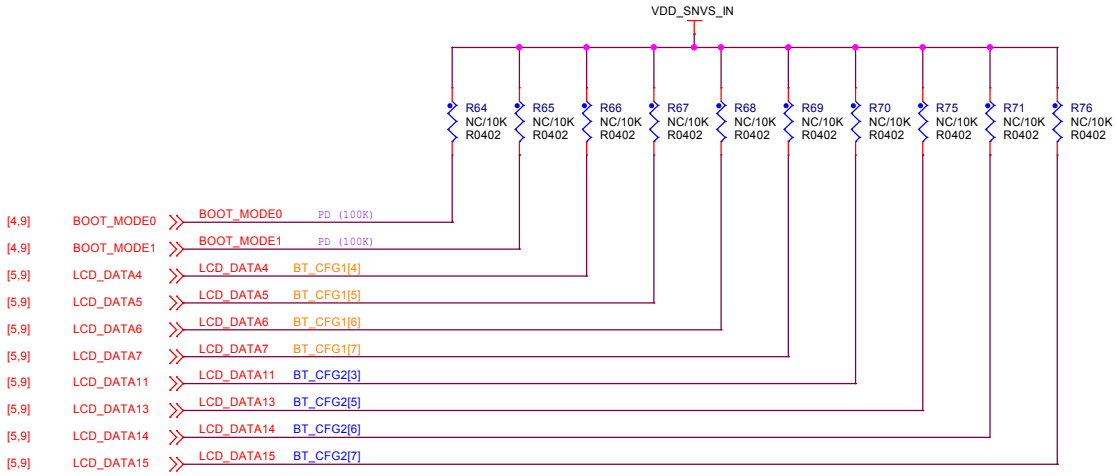
东莞野火电子技术有限公司 https://fire-stm32.taobao.com		
野火_i.MX 6ULL核心板_原理图		
A3	eMMC/NAND FLASH	V1.0
Monday, November 25, 2019	7	10

启动设置

默认从NAND flash启动

	BOOT_MODE1	BOOT_MODE0	BT_CFG1[4]	BT_CFG1[5]	BT_CFG1[6]	BT_CFG1[7]	BT_CFG2[3]	BT_CFG2[6]
USB	0	1	X	X	X	X	X	X
NAND	1	0	1	0	0	1	0	0
eMMC	1	0	0	1	1	0	1	1

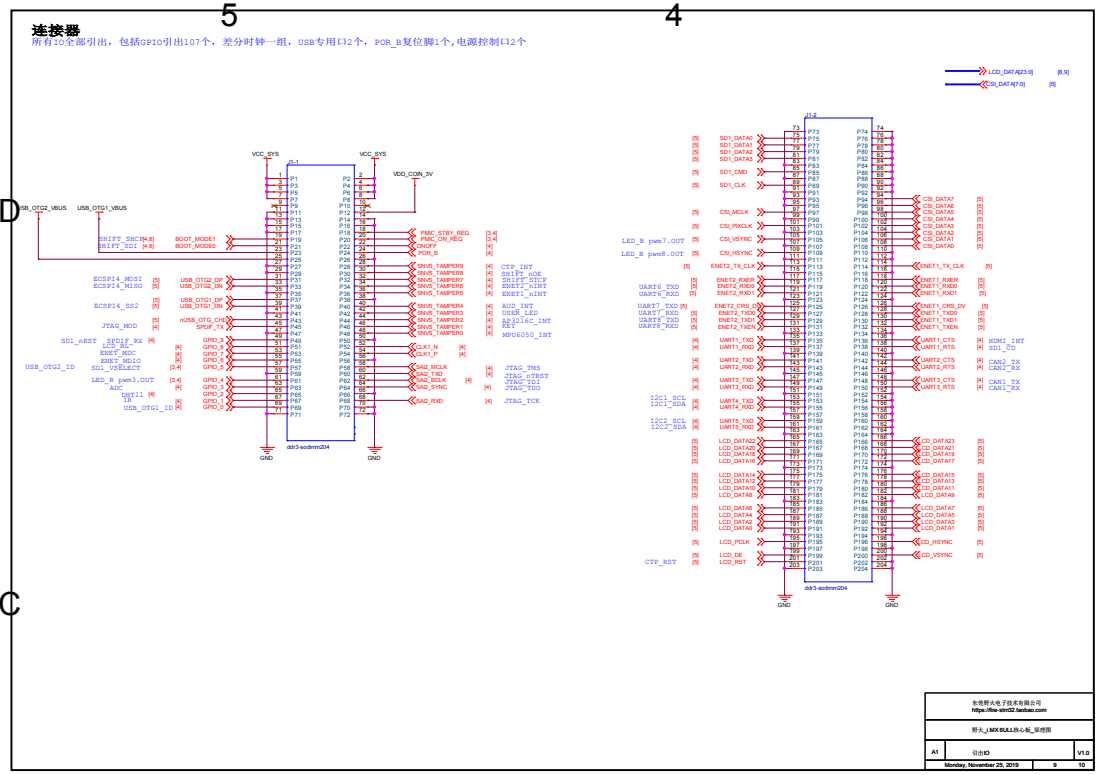
从NAND flash启动:焊R65、R67、R69
从eMMC启动:焊R65、R67、R68、R70、R71



东莞野火电子技术有限公司 https://fire-stm32.taobao.com		
野火_i.MX 6ULL核心板_原理图		
A3	BOOT CFG	V1.0
Monday, November 25, 2019	8	10

连接器

所有IO全部引出，包括GPIO引出107个，差分时钟一组，USB专用口2个，POR_B复位脚1个,电源控制口2个



东莞野火电子技术有限公司 https://fire-stm32.taobao.com		
野火_i.MX 6ULL核心板_原理图		
A1	引出IO	V1.0
Monday, November 25, 2019	9	10

FUSE MAP

TYPE	BOOT_CFG1[7]	BOOT_CFG1[6]	BOOT_CFG1[5]	BOOT_CFG1[4]	BOOT_CFG1[3]	BOOT_CFG1[2]	BOOT_CFG1[1]	BOOT_CFG1[0]
	0/1	0/1	0/1	1	0	0	0	0
QSPI	0	0	0	1	Reserved	DDRSMP: "000" : Default "001-111"		
WEIM	0	0	0	0	Memory Type: 0 - NOR Flash 1 - OneNAND	Reserved	Reserved	Reserved
Serial-ROM	0	0	1	1	Reserved	Reserved	Reserved	Reserved
SD/eSD	0	1	0	Fast Boot: 0 - Regular 1 - Fast Boot	SD/SDXC Speed 00 - Normal/SDR12 01 - High/SDR25 10 - SDR50 11 - SDR104		SD Power Cycle Enable '0' - No power cycle '1' - Enabled via USDHC_RST pad (uSDHC2 & 4 only)	SD Loopback Clock Source Selfor SDR50 and SDR104 only) '0' - through SD pad '1' - direct
MMC/eMMC	0	1	1	Fast Boot: 0 - Regular 1 - Fast Boot	SD/MMC Speed 0 - High! 1- Normal	Fast Boot Acknowledge Disable: 0 - Boot Ack Enabled 1 - Boot Ack Disabled	SD Power Cycle Enable '0' - No power cycle '1' - Enabled via USDHC_RST pad (uSDHC3 & 4 only)	SD Loopback Clock Source Selfor SDR50 and SDR104 only) '0' - through SD pad '1' - direct
NAND	1	BT_TOGGLEMODE	Pages in Block: 00 - 128 01 - 64 10 - 32 11 - 256		Nand Number Of Devices: 00 - 1 01 - 2 10 - 4 11 - Reserved		Nand_Row_address_bytes: 00 - 3 01 - 4 10 - 4 11 - 5	

TYPE	BOOT_CFG2[7]	BOOT_CFG2[6]	BOOT_CFG2[5]	BOOT_CFG2[4]	BOOT_CFG2[3]	BOOT_CFG2[2]	BOOT_CFG2[1]	BOOT_CFG2[0]
	0	0	0	0	1	0	0	0
QSPI	Reserved	HSIMS: Half Speed Phase Selection 0 : select sampling at non-inverted clock 1 : select sampling at inverted clock	HSDLY: Half Speed Delay selection 0 : one clock delay 1: two clock delay	FSPHS: Full Speed Phase Selection 0 : select sampling at non-inverted clock 1 : select sampling at inverted clock	FSDLY: Full Speed Delay selection 0 one clock delay 1 two clock delay	Boot Frequencies (ARM/DDR) 0 - 500 / 400 MHz 1 - 250 / 200 MHz	Reserved	Reserved
WEIM	Muxing Scheme: 00 - A/D16 01 - A+DH 10 - A+DL 11- Reserved		OneNand Page Size: 00 - 1KB 01 - 2KB 10 - 4KB 11 - Reserved		Reserved	Boot Frequencies (ARM/DDR) 0 - 500 / 400 MHz 1 - 250 / 200 MHz	Reserved	Reserved
Serial-ROM	Reserved	Reserved	Reserved	Reserved	Reserved	Boot Frequencies (ARM/DDR) 0 - 500 / 400 MHz 1 - 250 / 200 MHz	Reserved	Reserved
SD/eSD	SD Calibration Step '00' - 1 TBD		Bus Width: 0 - 1-bit 1 - 4-bit	Port Select: 00 - eSDHC1 01 - eSDHC2 10 - Reserved 11 - Reserved		Boot Frequencies (ARM/DDR) 0 - 500 / 400 MHz 1 - 250 / 200 MHz	SD1 VOLTAGE SELECTION 0 - 3.3V 1 - 1.8V	Reserved
MMC/eMMC	Bus Width: 000 - 1-bit 001 - 4-bit 010 - 8-bit 101 - 4-bit DDR (MMC 4.4) 110 - 8-bit DDR (MMC 4.4) Else - reserved.			Port Select: 00 - eSDHC1 01 - eSDHC2 10 - Reserved 11 - Reserved		Boot Frequencies (ARM/DDR) 0 - 500 / 400 MHz 1 - 250 / 200 MHz	SD1 VOLTAGE SELECTION 0 - 3.3V 1 - 1.8V	Reserved
NAND	Toggle Mode 33MHz Preamble Delay, Read Latency: '000' - 16 GPMICLK cycles. '001' - 1 GPMICLK cycles. '010' - 2 GPMICLK cycles. '011' - 3 GPMICLK cycles. '100' - 4 GPMICLK cycles. '101' - 5 GPMICLK cycles. '110' - 6 GPMICLK cycles. '111' - 7 GPMICLK cycles.			BOOT_SEARCH_COUNT: 00 - 2 01 - 2 10 - 4 11 - 8		Boot Frequencies (ARM/DDR) 0 - 500 / 400 MHz 1 - 250 / 200 MHz	Reset Time '0' - 12ms '1' - 22ms (LBA Nand)	Reserved

TYPE	BOOT_CFG4[7]	BOOT_CFG4[6]	BOOT_CFG4[5]	BOOT_CFG4[4]	BOOT_CFG4[3]	BOOT_CFG4[2]	BOOT_CFG4[1]	BOOT_CFG4[0]
	0	0	0	0	0	0	0	0
0x450	Infinit-Loop (Debug USE only) 0 - Disable 1- Enable	EEPROM Recovery Enable '0' - Disabled '1' - Enabled	CS select (SPI only): 00 - CS#0 (default) 01 - CS#1 10 - CS#2 11 - CS#3		SPI Addressing: 0 - 2-bytes (16-bit) 1 - 3-bytes (24-bit)		Port Select: 000 - eCSPI1 001 - eCSPI2 010 - eCSPI3 011 - eCSPI4 100 - Reserved 101 - Reserved 110 - Reserved 111 - Reserved	
0x460	L2_HW_INVALIDATE_DISABLE	Reserved	FORCE_COLD_BOOT (Reflected in SBMR2)	BT_FUSE_SEL	DIR_BT_DIS	Reserved	SEC_CONFIG[1]	Reserved
0x460	Reserved (DDR3 config options)							
0x460	JTAG_SMODE[1:0]	WDOG_ENABLE '0' - Disabled '1' - Enabled	SJC_DISABLE	Reserved	Reserved	Reserved	Reserved	Reserved
0x460	Reserved	Reserved	Reserved	TZASC_ENABLE	JTAG_HEO	KTE	Reserved	DLL_ENABLE 0 - Disable DLL for SD/eMMC 1 - Enable DLL for SD/Emmc
0x470	DLL Override: 0 - DLL Slave Mode for SD/eMMC 1 - DLL Override Mode for SD/eMMC	Reserved	SD2 VOLTAGE SELECTION 0 - 3.3V 1 - 1.8V	Reserved	Disable SDMMC Manufacture mode 0 - Enable 1 - Disable	L1 I-Cache DISABLE	BT_MMU_DISABLE	Override Pad Settings (using PAD_SETTINGS value)
0x470	Reserved for unexpected requirements	eMMC 4.4 - RESET TO PRE-IDLE STATE	Override HYS bit for SD/MMC pads	USDHC_PAD_PULL_DOWN 0 - no action 1 - pull down	ENABLE_EMMC_22K_PULLUP 0 - 47K pullup 1 - 22K pullup	ADD_DS__SET_GPR1_16 0 - Set 1 - Don't set	USDHC_IOMUX_SION_BIT_ENABLE 0 - Disable 1 - Enable	USDHC IOMUX SRE Enable 0 - Disable 1 - Enable
0x470	USDHC_CMD_OE_PRE_EN (SD/MMC debug)	LPB_BOOT (Core / DDR- Bus) '00' - LPB Disable '01' - 1 GPIO (def freq) '10' - Div by2 '11' - Div by 4		BT_LPB_POLARITY (GPIO polarity)	POWER_MNG_CFG (LDO's DCDC's) (Reserved - NOT USED)			
0x470	Override NAND Pad Settings (using PAD_SETTINGS value)	MMC_DLL_DLY[6:0] Delay target for SD/eMMC DLL, it is applied to slave mode target delay or override mode target delay depends on DLL Override fuse bit value.						

东莞野火电子技术有限公司
https://fire-stm32.taobao.com

野火_i.MX 6UL核心板_原理图

A2	FUSE MAP	V1.0
Monday, November 25, 2019	10	10